

MECOP Intern 2019: Buckeye Born, Duck Raised, Beaver for Life!

Nick Eichner is this year's MECOP (Multiple Engineering Cooperative) intern at Silicon Forest Electronics. Nick is going into his senior year in Industrial and Manufacturing Engineering at Oregon State University and graduating in March 2020. He is an active member in the Institute of Industrial & Systems Engineering (IISE) and Society of Manufacturing Engineers (SME); he attended the IISE Annual Conference 2019 in May to learn from the field's subject matter experts.

Having been born in Columbus, Ohio and moving to Eugene, Oregon at 11 years old, he has grown to love learning about new places and people. Through participation in MECOP internships, these experiences have led to a passion for learning processes from inside-out. Nick looks forward to becoming a Process Engineer or Systems Engineer to have a hand in developing and managing processes.



A few of Nick's projects with SFE include the automation of epoxy dispensing to further utilize our automated dispensing equipment, establishing a new control limit for PCBA cleanliness testing, designing and 3D printing tooling for production, and assisting in our New Product Introduction process.

We look forward to seeing the results of Nick's projects, and the culmination of a productive 2019 internship.....and beyond!

Contributed by:

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